

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WOONCHUN KIM	01/05/2022
SEUNGWAN SHIN	01/05/2022
GUN LEE	01/05/2022
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17707002
CORRESPONDENCE DATA	
Fax Number:	(571)283-0740
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	VOLENTINE, WHITT & FRANCOS, PLLC
Address Line 1:	300 E MAIN ST., SUITE 302
Address Line 4:	CHARLOTTESVILLE, VIRGINIA 22902
ATTORNEY DOCKET NUMBER:	SEC.4906
NAME OF SUBMITTER:	ADAM C. VOLENTINE
SIGNATURE:	/ADAM C. VOLENTINE/
DATE SIGNED:	03/29/2022
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 4	
source=Declaration_Assignment_Form#page1.tif	
source=Declaration_Assignment_Form#page2.tif	
source=Declaration_Assignment_Form#page3.tif	

**COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY PATENT APPLICATION AND
ASSIGNMENT FORM¹**

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

Title: **SEMICONDUCTOR PACKAGE AND METHOD OF MANUFACTURING SAME**

for which Assignor is about to make or has made United States or International application for patent.

WHEREAS, as a below named inventor(s), I/(we) hereby declare that:

Section I. Declaration

This declaration is directed to:

- ☒ The attached U.S. non-provisional patent application, or
- ☐ U.S. non-provisional patent application number _____, filed on _____, or
- ☐ PCT international patent application number _____, filed on _____.

The above-identified application was made or authorized to be made by me (us).

I (we) believe that I am (we are) the original inventor (original joint inventors) of a claimed invention in the above-identified application.

I (we) hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

¹ This form requires the use of an Application Data Sheet.

SEC Ref No.

II-202105-011-1-US0

Attorney Ref No.

**OPP-2021-1290-34521
SEC.4906**

SAMSUNG ELECTRONICS CO., LTD.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge that I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do 16677, Republic of Korea (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United

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Attorney Ref No.

OPP-2021-1290-34521

SEC.4906

LEGAL NAME OF SECOND INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Shin	Seungwan	
<p>SIGNATURE <u>Seungwan Shin</u> DATE <u>Jan. 5, 2022</u></p>			

LEGAL NAME OF THIRD INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	Lee	Gun	
<p>SIGNATURE <u>Gun Lee</u> DATE <u>Jan. 5, 2022</u></p>			